

Special Issue

Transportation Planning, Management and Optimization: 2nd Edition

Message from the Guest Editor

In this Special Issue, recent efforts and advances made for intelligent transport planning, management, and optimization will be discussed. The topics of interest include, but are not limited to, the following research areas:

- AI for sustainable transportation and manufacturing;
- Deep learning for recyclable material transportation;
- Plan and forecast network needs;
- Smart transportation route optimization;
- Machine learning for transportation efficiency improvement;
- Intelligent reverse logistic technology;
- Integration of manufacturing, transportation, and recycling;
- Related value assessment and pricing strategy;
- IoT for smart transportation, manufacturing, and warehousing.

Guest Editor

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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